AIRCHI FDP6030L/FDB6030L N-Channel Logic Level PowerTrench[®] MOSFET **General Description** Features This N-Channel Logic Level MOSFET has been • 48 A, 30 V $R_{DS(ON)}$ = 13 m Ω @ V_{GS} = 10 V designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers.

These MOSFETs feature faster switching and lower gate charge than other MOSFETs with comparable R_{DS(ON)} specifications.

The result is a MOSFET that is easy and safer to drive (even at very high frequencies), and DC/DC power supply designs with higher overall efficiency.

It has been optimized for low gate charge, low R_{DS(ON)} and fast switching speed.

- $R_{DS(ON)} = 17 \text{ m}\Omega @ V_{GS} = 4.5 \text{ V}$
- Critical DC electrical parameters specified at elevated temperature
- High performance trench technology for extremely low R_{DS(ON)}

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175°C maximum junction temperature rating



Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol	Parameter	Ratings	Units
V _{DSS}	Drain-Source Voltage	30	V
V _{GSS}	Gate-Source Voltage	± 20	V
ID	Drain Current – Continuous (Note 1)	48	А
	– Pulsed	150	
PD	Total Power Dissipation @ T _c = 25°C	52	W
	Derate above 25°C	0.3	W/°C
T _J , T _{STG}	Operating and Storage Junction Temperature Range	-65 to +175	°C

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$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	2.9	°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	62.5		

Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape width	Quantity
FDB6030L	FDB6030L	13"	24mm	800 units
FDP6030L	FDP6030L	Tube	n/a	45

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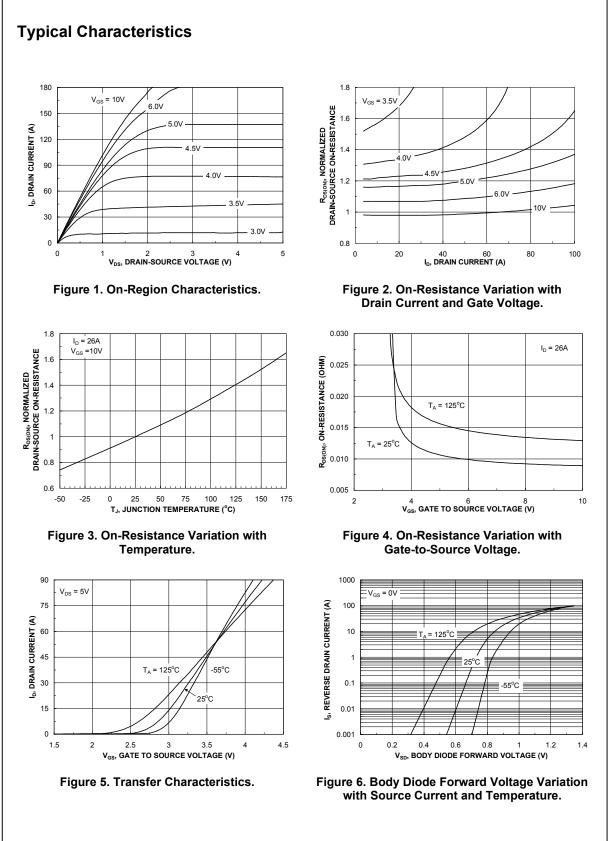


Symbol	Parameter	Test Conditions	Min	Тур	Мах	Units
-	Durce Avalanche Ratings (Note					
E _{AS}	Single Pulse Drain-Source	$V_{DD} = 15 V, I_D = 26 A$			100	mJ
-43	Avalanche Energy					
I _{AS}	Maximum Drain-Source Avalanche Current				26	A
Off Char	acteristics					
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$, $I_{D} = 250 \mu A$	30			V
<u>ΔBVdss</u> ΔTj	Breakdown Voltage Temperature Coefficient	I_D = 250 μ A, Referenced to 25°C		23		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 24 V$, $V_{GS} = 0 V$			1	μA
I _{GSS}	Gate–Body Leakage	V_{GS} = ± 20 V, V_{DS} = 0 V			± 100	nA
On Char	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1	1.9	3	V
$\Delta V_{GS(th)} \Delta T_J$	Gate Threshold Voltage Temperature Coefficient	I_D = 250 μ A, Referenced to 25°C		-5		mV/°C
R _{DS(on)}	Static Drain–Source On– Resistance			7.9 10.2 13.0	13 17 20	mΩ
I _{D(on)}	On–State Drain Current	$V_{GS} = 10 \text{ V}, V_{DS} = 10 \text{ V}$	60			Α
g _{FS}	Forward Transconductance	$V_{DS} = 10V, I_D = 26 A$		68		S
	c Characteristics					
C _{iss}	Input Capacitance	$V_{DS} = 15 V$, $V_{GS} = 0 V$,		1250		pF
Coss	Output Capacitance	f = 1.0 MHz		330		pF
	Reverse Transfer Capacitance	_		155		<u>'</u>
C _{rss} R _G	Gate Resistance	V _{GS} = 15 mV, f = 1.0 MHz		1.3		pF Ω
-		$V_{GS} = 15 11V, 1 = 1.0 10112$		1.5		52
	Turn–On Delay Time		1	11	20	
t _{d(on)} t _r	Turn–On Delay Time	V_{DD} = 15V, I_D = 1 A, V_{GS} = 10 V, R_{GEN} = 6 Ω		12	20	ns ns
	Turn–Off Delay Time	_		29	46	ns
t _{d(off)} t _f	Turn-Off Fall Time	-		12	21	ns
q Qg	Total Gate Charge	V _{DS} = 15 V, I _D = 26 A,		13	18	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = 5 V$		3.9	10	nC
Q _{gd}	Gate-Drain Charge	-		5.2		nC
	5	and Maximum Datings		0.2		
Drain-5	ource Diode Characteristics				48	A
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$, $I_S = 26 A$ (Note 1)		0.92	1.3	V
t _{rr}	Diode Reverse Recovery Time	I _F = 26 A,		26		nS
Q _{rr}	Diode Reverse Recovery Charge	$d_{iF}/d_t = 100 \text{ A}/\mu\text{s}$		15		nC

1. Calculated continuous current based on maximum allowable junction temperature.

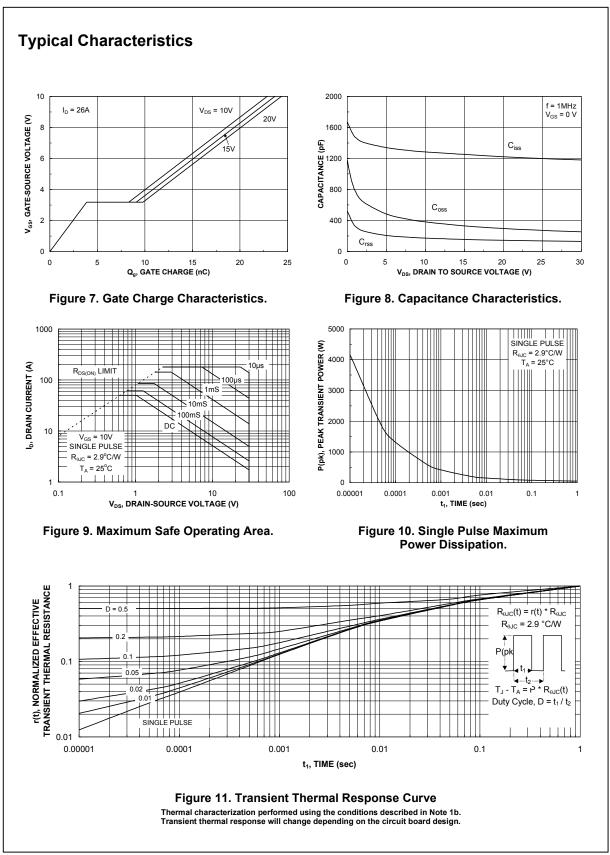
2. Pulse Test: Pulse Width < 300µs, Duty Cycle < 2.0%

FDP6030L/FDB6030L



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FDP6030L/FDB6030L Rev E(W)



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The Power Franchise™ Programmable Active Droop™		POP™	SuperSOT™-3		

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